MHP20S TO-126 Series **Power Resistor**



MHP20S Series

- TO-126 housing
- Low inductance (<50nH)
- Power dissipation up to 20W
- High stability film resistance elements
- RoHS compliant



IRC's TO-126 power film resistors satisfy demanding applications for accurate and stable power resistors housed in the convenient TO-126 case.

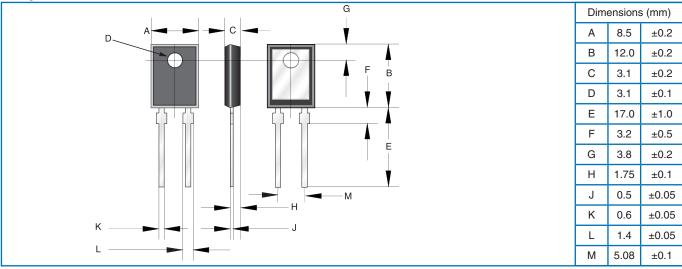
The resistance element is isolated from the mounting tab by an alumina ceramic layer, providing high thermal conductivity and excellent insulation resistance between terminals and tab. The low inductance design makes these products especially useful in high frequency and high speed pulse applications.

Specification Data

TypePower	Power Rating¹		Voltage Rating⁴	Thermal Resistance	Resistance	Tolerances	Preferred Values	Temperature Coefficient
	Heatsink ²	Free Air ³	nailing.	nesistance	Range (Ω)		values	Coemcient
MHP20SLF	20W	1W	500	5.9°C/W	0.01 - 0.09	±5%	E6	±250ppm/°C
MHP20SLF	20W	1W			0.1 - 51K	±1%, ±5%	E24	±100ppm/°C

¹Maximum current 25 amps

Physical Data



General Note

IRC reserves the right to make changes in product specification without notice or liability All information is subject to IRC's own data and is considered accurate at time of going to print.



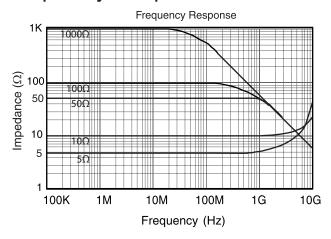
²Power rating based on 25°C case temperature ³Power rating based on 25°C ambient temperature

⁴Maximun voltage or √PxR

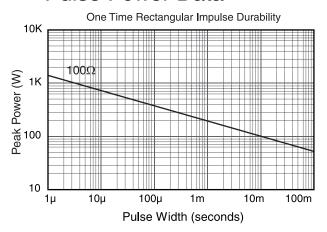
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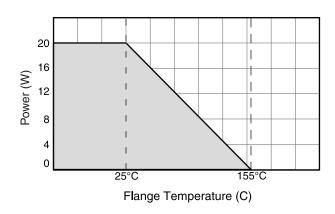
Frequency Response Data



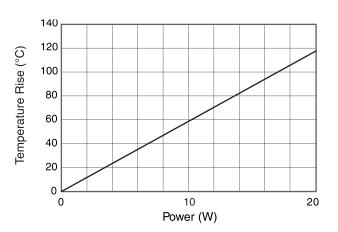
Pulse Power Data



Power Derating Data



Temperature Rise Data



Environmental Data

Item	Test Conditions	Specification - Performance	
Operating Temperature Range		-55°C to 155°C	
Dielectric Withstanding Voltage	60 seconds, between leads connected together and metal back plate	2000VDC	
Load Life	25°C, 90 min. ON, 30 min. OFF, 1000 hours	Δ R ±1.0% + 0.05 Ω	
Moisture Resistance	40°C, 90-95% RH, DC 0.1W, 1000 hours	Δ R ±1.0% + 0.05 Ω	
Solderability*	230 ± 5°C, 3 sec.	>75% coverage	
Insulation Resistance	Between leads and metal back plate	> 1000MΩ	
Vibration	IEC60068-2-6	∆ R ±0.25%	

^{*} During soldering, the soldering temperature profile must not cause the metal back plate of this device to exceed 220°C

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Ordering Data

Prefix·····TFP - MHP20SLF - 1R50 - J
Style · · · · ·
Resistance Code · · · · · · · · · · · · · · · · · · ·
4-digit resistance code. Ex: $10R0 = 10\Omega$, $1K00 = 1K\Omega$
Tolerance Code

Packaging

Standard packaging is RoHS PS/PE tube packaging (60 pieces per tube).

Application Notes:

- 1. Insulating material is unnecessary between the heat sink and the tab as the resistor film is insulated by the internal alumina substrate.

 2. When mounting with a fastner, thermal grease is recommended.

 3. Thermal design should satisfy the following equation: Case Temperature (Tc)-+ [Thermal Resistance (RθJC) x Power applied (Watts)] ≤ 155°C over the full operating temperature range of the application.

 4. Leads are lead free. Internal connections contain Pb that are exempted under RoHS directive 2002/95/EC, exemption 7.